



January 27, 2011

To: John D' Ambrosia, Chair of the IEEE 802.3 100 Gb/s Backplane and Copper Cable Study Group

Subject: Q1 2011 Liaison from OIF to IEEE 802.3 100 Gb/s Backplane and Copper Cable Study Group

From: Jonathan Sadler, OIF Technical Committee Chair (jonathan.sadler@tellabs.com)

Dear Mr. D' Ambrosia,

Thank you for the liaison from your newly formed study group. The OIF looks forward to cooperating with the IEEE 802.3 to the mutual benefit of both organizations. Per your request, please find attached the OIF's draft agreement for the CEI-25G-LR (OIF2008.161.11). In addition, based on your general request for applicable documents, we have attached Test Methodologies for CEI-28G-SR and CEI-25G-LR (OIF2010.189.05).

Sincerely,

A handwritten signature in black ink, appearing to read "Jonathan Sadler", written in a cursive style.

Jonathan Sadler
OIF Technical Committee Chair

CC: Paul Nikolich, Chair IEEE, 802 LMSC (p.nikolich@ieee.org)
David Law, Chair IEEE 802.3 Ethernet Working Group (dlaw@hp.com)
Wael Diab, Vice Chair IEEE 802.3 Ethernet Working Group (wdiab@broadcom.com)
Adam Healey, Secretary IEEE 802.3 Ethernet Working Group (adam.healey@lsi.com)
Tom Palkert, Liaison between OIF and IEEE 802.3 100 Gb/s Backplane and Copper Cable study group (tpalkert@luxtera.com)